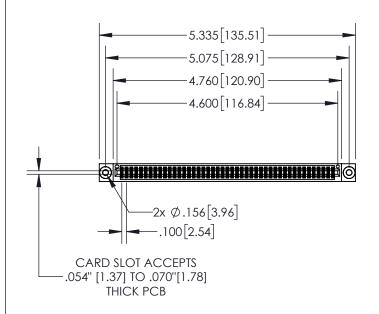
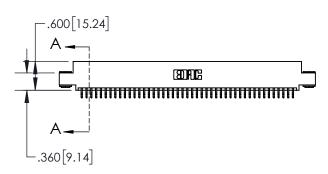
Contact Dimensions:

556-Extender Board Bend (Code 520 Contacts)
See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions





- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE



1

.330[8.38] CARD SLOT				
.160[4.06] POINT OF CONTACT				
200[5.08]				

845/895 SEF	RIES HIGH TEMP	CARD EDG	E CONNECTOR
PART NUMB	ER: 895-090-55	6-503	

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MASTER		
DRAWN: R.STA.MONICA	DATE:MAY.16/2017	
CHECKED:	DATE:	
SCALE: 1:2	SHEET 1 OF 2	
DRAWING NUMBER	ISSUE	

845-ENG-MASTER







- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL; COPPER ALLOY

CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MAS			
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017	
	CHECKED:	DATE:	
	SCALE: 1:1	SHEET 2 OF 2	
D	DRAWING NUMBER	ISSUE	

845-ENG-MASTER